



#### **30V P-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

| V <sub>(BR)</sub> dss | Max R <sub>DS(ON)</sub>                 | Package | Max I <sub>D</sub><br>T <sub>A</sub> = +25°C |
|-----------------------|---|---------|--|
| 201/                  | 0.21Ω @ V <sub>GS</sub> = -10V          | SOT23   | -1.6A  |
| -300                  | -30V<br>0.33Ω @ V <sub>GS</sub> = -4.5V |         | -1.1A  |

#### Description

This new generation of trench MOSFETs utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, and power management applications.

## Applications

- DC-DC Converters
- Power Management Functions
- Disconnect Switches
- Motor Control

#### Features

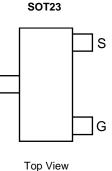
- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (€3)
- Weight: 0.008 grams (Approximate)

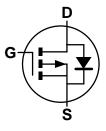


Top View



D

Pin Out



Equivalent Circuit

#### Ordering Information (Note 4)

| Part Number | Compliance | Case  | Quantity per Reel |
|-------------|------------|-------|-------------------|
| ZXMP3A13FTA | Standard   | SOT23 | 3,000             |
| ZXMP3A13FTC | Standard   | SOT23 | 10.000            |

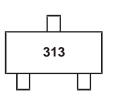
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



313 = Product Type Marking Code



## **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic                                  |                       |                        | Symbol                           | Value           | Units                |   |
|---|-----------------------|------------------------|----------------------------------|-----------------|----------------------|---|
| Drain-Source Voltage                            |                       |                        | V <sub>DSS</sub>                 | -30             | V                    |   |
| Gate-Source Voltage                             |                       |                        | V <sub>GS</sub>                  | ±20             | V                    |   |
| Continuous Drain Current                        | V <sub>GS</sub> = 10V | T <sub>A</sub> = +70°C | (Note 6)<br>(Note 6)<br>(Note 5) | ID              | -1.6<br>-1.3<br>-1.4 | A |
| Pulsed Drain Current (Note 7)                   |                       |                        |                                  | I <sub>DM</sub> | -6                   | A |
| Continuous Source Current (Body Diode) (Note 6) |                       |                        | ls                               | -1.2            | A                    |   |
| Pulsed Source Current (Body Diode) (Note 7)     |                       |                        | I <sub>SM</sub>                  | -6              | A                    |   |

#### **Thermal Characteristics**

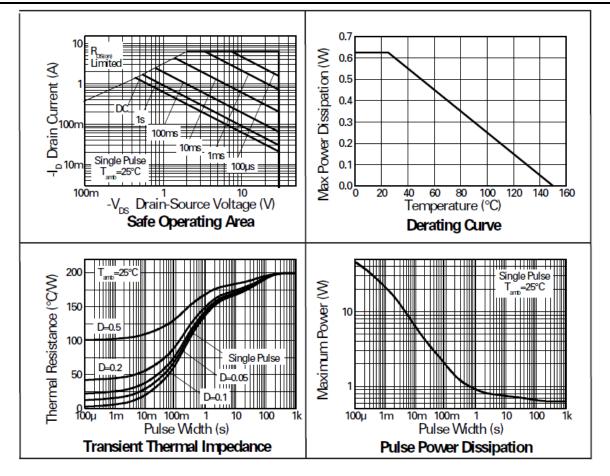
| Characteristic                                       | Symbol                           | Value       | Unit        |
|--|----------------------------------|-------------|-------------|
| Power Dissipation (Note 5)<br>Linear Derating Factor | PD                               | 625<br>5    | mW<br>mW/°C |
| Power Dissipation (Note 6)<br>Linear Derating Factor | PD                               | 806<br>6.4  | mW<br>mW/°C |
| Thermal Resistance, Junction to Ambient (Note 5)     | R <sub>0JA</sub>                 | 200         | °C/W        |
| Thermal Resistance, Junction to Ambient (Note 6)     | R <sub>0JA</sub>                 | 155         | °C/W        |
| Operating and Storage Temperature Range              | T <sub>J,</sub> T <sub>STG</sub> | -55 to +150 | °C          |

Notes:

5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions 6. For a device surface mounted on FR4 PCB measured at t ≤5 secs.
7. Repetitive rating 25mm x 25mm FR4 PCB, D=0.05 pulse width=10µs - pulse current limited by maximum junction temperature.



#### **Thermal Characteristics**





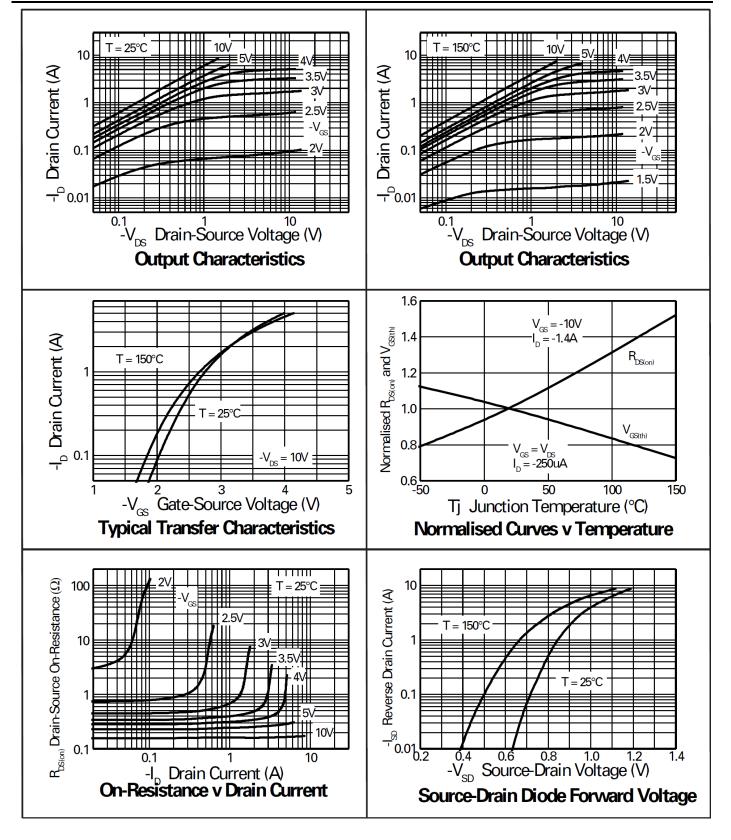
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                             | Cumphial            | Min  | True  | Max   | 11   | Test Condition  |
|--|---------------------|------|-------|-------|------|---|
| Characteristic<br>OFF CHARACTERISTICS      | Symbol              | Min  | Тур   | Max   | Unit | Test Condition  |
|  | D)/                 | 20   |       |       | V    |   |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | -30  |       | -     | V    | $I_D = -250\mu A, V_{GS} = 0V$  |
| Zero Gate Voltage Drain Current            | IDSS                | _    | _     | -0.5  | μA   | $V_{DS} = -30V, V_{GS} = 0V$  |
| Gate-Source Leakage                        | I <sub>GSS</sub>    | —    | —     | ±100  | nA   | $V_{GS} = \pm 20V, V_{DS} = 0V$   |
| ON CHARACTERISTICS                         |                     |      | 1     | 1     |      |   |
| Gate Threshold Voltage                     | V <sub>GS(th)</sub> | -1.0 |       | _     | V    | $I_D = -250\mu A$ , $V_{DS} = V_{GS}$   |
| Static Drain-Source On-Resistance (Note 8) | R <sub>DS(ON)</sub> | _    | _     | 0.21  | Ω    | $V_{GS} = -10V, I_D = -1.4A$  |
|  | NDS(ON)             |      |       | 0.33  | 32   | $V_{GS} = -4.5V, I_D = -1.1A$   |
| Forward Transconductance (Notes 8 & 10)    | <b>g</b> fs         | _    | 2.4   | _     | S    | $V_{DS} = -15V, I_D = -1.4A$  |
| DYNAMIC CHARACTERISTICS (Note 10)          |                     |      |       |       |      |   |
| Input Capacitance                          | C <sub>iss</sub>    | _    | 206   | _     |      |   |
| Output Capacitance                         | Coss                | _    | 59.3  | _     | pF   | $V_{DS} = -15V, V_{GS} = 0V$<br>f = 1.0MHz  |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    |      | 49.2  | _     | 1    |   |
| SWITCHING (Notes 9 & 10)                   |                     |      |       |       |      | -   |
| Turn-On Delay Time                         | t <sub>d(ON)</sub>  | _    | 1.5   | _     |      | $\label{eq:VDD} \begin{split} V_{DD} = -15V, \ I_D = -1.0A, \\ R_G \cong 6.0\Omega \ , \ V_{GS} = -10V \end{split}$ |
| Rise Time                                  | t <sub>R</sub>      | _    | 3.0   | —     | nS   |   |
| Turn-Off Delay Time                        | t <sub>D(OFF)</sub> | _    | 11.1  | _     | 113  |   |
| Fall Time                                  | t <sub>f</sub>      | _    | 7.6   |       |      |   |
| Gate Charge                                | Qg                  | _    | 3.8   | _     | nC   | V <sub>DS</sub> = -15V, V <sub>GS</sub> = -5.0V,<br>I <sub>D</sub> = -1.4A  |
| Total Gate Charge                          | Qq                  |      | 6.4   | _     |      | $V_{DS} = -15V, V_{GS} = -10V,$<br>$I_D = -1.4A$  |
| Gate-Source Charge                         | Q <sub>gs</sub>     |      | 0.69  | _     | nC   |   |
| Gate-Drain Charge                          | Q <sub>gd</sub>     |      | 2.0   |       | ]    |   |
| SOURCE-DRAIN DIODE                         | 1 37 1              |      | •     | •     | •    | •   |
| Diode Forward Voltage (Note 8)             | V <sub>SD</sub>     |      | -0.85 | -0.95 | V    | $T_J = +25^{\circ}C, I_S = -1.1A, V_{GS} = 0V$  |
| Reverse Recovery Time (Note 10)            | t <sub>RR</sub>     |      | 15.6  | —     | nS   | T <sub>J</sub> = +25°C, I <sub>F</sub> = -0.95A,  |
| Reverse Recovery Charge (Note 10)          | Q <sub>RR</sub>     |      | 9.6   |       | nC   | di/dt = 100A/µs   |

 8. Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%.
 9. Switching characteristics are independent of operating junction temperature.
 10. For design aid only, not subject to production testing. Notes:

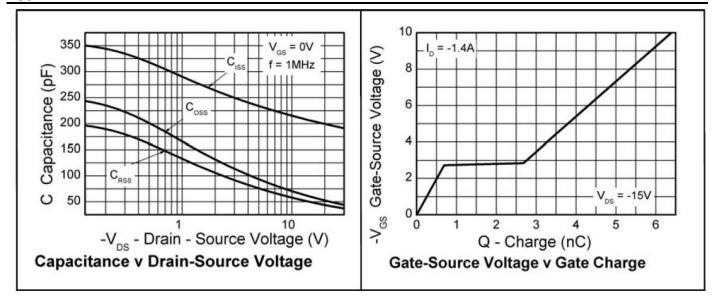


## **Typical Characteristics**

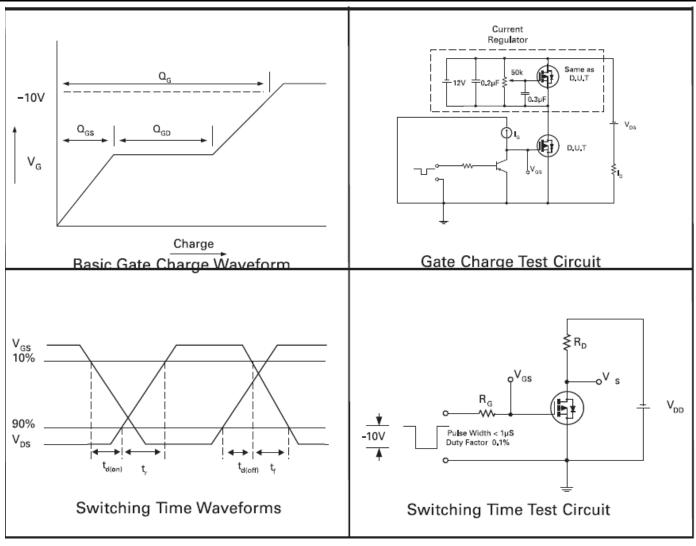




#### Typical Characteristics (Continued)



**Test Circuits** 

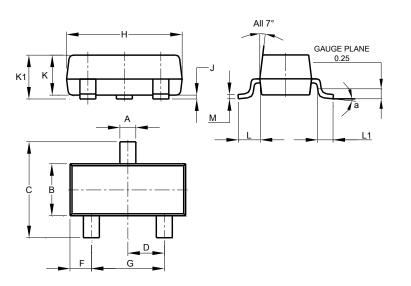


ZXMP3A13F Document number: DS33573 Rev. 2 - 2



## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

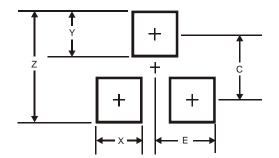


| SOT23                |       |       |       |  |  |
|----------------------|-------|-------|-------|--|--|
| Dim                  | Min   | Max   | Тур   |  |  |
| Α                    | 0.37  | 0.51  | 0.40  |  |  |
| В                    | 1.20  | 1.40  | 1.30  |  |  |
| С                    | 2.30  | 2.50  | 2.40  |  |  |
| D                    | 0.89  | 1.03  | 0.915 |  |  |
| F                    | 0.45  | 0.60  | 0.535 |  |  |
| G                    | 1.78  | 2.05  | 1.83  |  |  |
| н                    | 2.80  | 3.00  | 2.90  |  |  |
| J                    | 0.013 | 0.10  | 0.05  |  |  |
| K                    | 0.890 | 1.00  | 0.975 |  |  |
| K1                   | 0.903 | 1.10  | 1.025 |  |  |
| L                    | 0.45  | 0.61  | 0.55  |  |  |
| L1                   | 0.25  | 0.55  | 0.40  |  |  |
| М                    | 0.085 | 0.150 | 0.110 |  |  |
| а                    | 8°    |       |       |  |  |
| All Dimensions in mm |       |       |       |  |  |

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOT23



| Dimensions | Value (in mm) |  |  |
|------------|---------------|--|--|
| Z          | 2.9           |  |  |
| Х          | 0.8           |  |  |
| Y          | 0.9           |  |  |
| С          | 2.0           |  |  |
| E          | 1.35          |  |  |

SOT23



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